

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re Patent Application of:  
Hung-Wen SU et al.

Application No.: 10/814,175

Confirmation No.: 7374

Filed: April 1, 2004

Art Unit: 1795

For: METHOD AND APPARATUS FOR  
ELECTROPLATING

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Examiner: H. D. Wilkins III

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

**MS Amendment**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated December 12, 2007, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.